



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Dittmar, *et al.* Docket No.: INF 2002 P 09188 US
Serial No.: 10/519,741 Art Unit: 2812
Filed: November 4, 2005 Examiner: Thu Huong Dinh
For: Method for Contacting Parts of a Component Integrated into a
Semiconductor Substrate

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

ATTN: Examiner Dinh

CORRESPONDENCE

Thank you for your telephone call of February 4, 2008 to discuss the above referenced application.

As we discussed, you have authorization to issue an Examiner's Amendment to:

- (1) Amend the first element of claim 21 as follows:
"Providing a hard mask patterned over an insulating layer to define a contact hole;" and
- (2) Amend page 6, line 24 of the application (paragraph [0067], lines 7 and 8 of the published application) to delete the words "as shown in Fig. 8" and substitute before --reference number 13 not shown--.

It is Applicants understanding with these changes, the application will be in condition for allowance.

Respectfully submitted,

9 Feb 2008
Date

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